

C2225C681KBRACTU

Aliases (C2225C681KBRAC7800)

SMD Comm X7R HV, Ceramic, 680 pF, 10%, 630 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 2225, 3.2 mm



General Information		
Series	SMD Comm X7R HV	
Style	SMD Chip	
Description	SMD, MLCC, High Voltage, Temperature Stable	
Features	High Voltage	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	430 mg	
Shelf Life	78 Weeks	
MSL	1	

Dimensions	
Chip Size	2225
L	5.6mm +/-0.4mm
W	6.4mm +/-0.4mm
Т	1.6mm +/-0.20mm
S	3.2mm MIN
В	0.6mm +/-0.35mm

VV	6.411111 +/ -0.411111
Т	1.6mm +/-0.20mm
S	3.2mm MIN
В	0.6mm +/-0.35mm
Packaging Specifications	

Specifications		
Capacitance	680 pF	
Measurement Condition	1 kHz 1.0Vrms	
Tolerance	10%	
Voltage DC	630 VDC	
Dielectric Withstanding Voltage	945 VDC	
Temperature Range	-55/+125°C	
Temp. Coefficient	X7R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms	
Dissipation Factor	2.5% 1 kHz 1.0Vrms	
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	100 GOhms	

Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and Applied (TCC)
Packaging Quantity	ing Quantity 1000	Dissipation Factor
		Aging Rate

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